

Customer Information Notification

202501032I: Datasheet Correction for Several NXP UART Bridge Devices

Note: This notice is NXP Company

Proprietary.

Issue Date: Feb 12, 2025 Effective Date: Feb 13, 2025

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Management summary

NXP announces a SC16IS741A, SC16IS740/750/760, SC16C752B and SC16IS752; SC16IS762 datasheet correction.

Change Category

[]Wafer Fab Process	[]Assembly Process	[]Test Process	[]Design
[]Wafer Fab Materials	[]Assembly Materials []Mechanical Specification	[]Test Equipment	[]Errata
[]Wafer Fab Location	[]Assembly []Packing/Shipping/Labeling Location	[]Test Location	[]Electrical spec./Test coverage
[]Firmware [X]Other: Datasheet			

Notification Overview

Description

Corrected the value of the first item of column "Divisor used to generate 16x clock" from 2304 to 3840 in the table "Baud rates using a 3.072 MHz crystal"

Reason

Correction to the 50 bit/s divisor value from 2304 to 3840 for a 3.072 MHz crystal (due to a typo).

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

Data Sheet Revision

A new data sheet will be issued

Additional information

Additional documents: view online

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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